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Analytical review of the ideas and the current state of the Extreme Ultraviolet (EUV) nanolithography, as well as Deep Ultraviolet (DUV) lithography, with elements of the original study is presented. The key factors having an influence on photolithography process resolution like wavelength and numerical aperture dependences, along with reduction possibilities of the "technological" coefficient in the expression for a minimal stripe resolved by photolithography are considered. The data on development of the native model of the Experimental Nanolithography Tool aimed at most high resolution are presented. Limiting resolution of the method of EUV Lithography is estimated as well as prospects of further achievement of the several nanometers resolution necessary for creation of any nanostructure is estimated.

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Potyagalova A. S., Soltan I. E., Tkachev D. F., Khapaev M. M.

Practical Technique for Reduced-Order Modeling of RLCK Circuits Based on Krylov Space Methods

In this paper, we present an implementation of model order reduction (MOR) for resistance-inductance-capacitance (RLCK) network. The algorithm generates guaranteed-passive models using numerically stable and efficient Krylov-subspace iterations. A result of reduction algorithm is a small network whose port behavior is similar to that of large RLCK-network. Further it is shown how to reduce a model via congruence transformations of matrix pencil. This paper presents some results of comparison simulation for full and reduced networks.

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